SM4TY

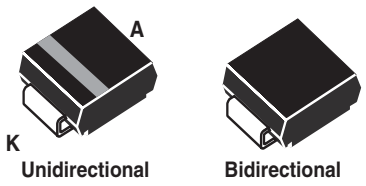
Automotive 400 W Transil™

Features

- peak pulse power:
  - 400 W (10/1000 µs)
  - 2.3 kW (8/20 µs)
- stand-off voltage range: from 5 V to 58 V
- unidirectional and bidirectional types
- low leakage current:
  - 0.2 µA at 25 °C
  - 1 µA at 85 °C
- operating $T_{j\ max}$: 150 °C
- high power capability at $T_{j\ max}$:
  - 270 W (10/1000 µs)
- JEDEC registered package outline
- resin meets UL 94, V0
- AEC-Q101 qualified

Complies with the following standards

- IEC 61000-4-2 level 4:
  - 15 kV (air discharge)
  - 8 kV (contact discharge)
- ISO 10605, C = 330 pF, R = 330 Ω:
  - 15 kV (air discharge)
  - 8 kV (contact discharge)
- ISO 7637-2 (for pulse 1 and 2a, applicable only to parts with stand-off voltage (V_{RM}) lower than the average battery voltage: 13.5 V):
  - pulse 1: V_S = -100 V
  - pulse 2a: V_S = +50 V
  - pulse 3a: V_S = -150 V
  - pulse 3b: V_S = +100 V



SMA
(JEDEC DO-214AC)

Description

The SM4TY Transil series has been designed to protect sensitive automotive circuits against surges defined in ISO 7637-2 and against electrostatic discharges according to IEC 61000-4-2 and ISO 10605.

The planar technology makes it compatible with high-end circuits where low leakage current and high junction temperature are required to provide reliability and stability over time. SM4TY devices are packaged in SMA (SMA footprint in accordance with IPC 7531 standard).

TM: Transil is a trademark of STMicroelectronics

1 Characteristics

Table 1. Absolute maximum ratings (T_{amb} = 25 °C)

Symbol	Parameter		Value	Unit
V_{PP}	Peak pulse voltage	ISO 10605 (C = 330 pF, R = 330 Ω) Contact discharge Air discharge IEC 61000-4-2 Contact discharge Air discharge	 30 30 30 30	kV
P_{PP}	Peak pulse power dissipation(1)	$T_{j\ initial} = T_{amb}$	400	W
T_{stg}	Storage temperature range		-65 to + 150	°C
T_j	Operating junction temperature range		-55 to + 150	°C
T_L	Maximum lead temperature for soldering during 10 s.		260	°C

1. For a surge greater than the maximum values, the diode will fail in short-circuit.

Table 2. Thermal parameter

Symbol	Parameter	Value	Unit
$R_{th(j-l)}$	Junction to leads	30	°C/W
$R_{th(j-a)}$	Junction to ambient on printed circuit on recommended pad layout	120	°C/W

Figure 1. Electrical characteristics - definitions

Symbol	Parameter
V_{RM}	Stand-off voltage
V_{BR}	Breakdown voltage
V_{CL}	Clamping voltage
I_{RM}	Leakage current @ V_{RM}
I_{PP}	Peak pulse current
αT	Voltage temperature coefficient
V_F	Forward voltage drop
R_D	Dynamic resistance

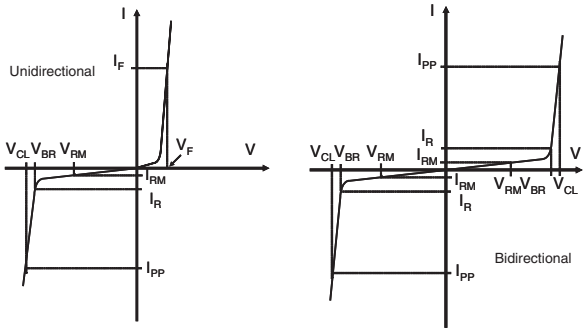


Figure 2. Pulse definition for electrical characteristics

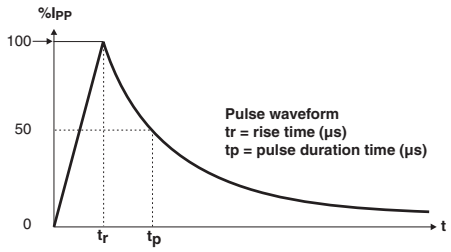


Table 3. Electrical characteristics, typical values if not otherwise stated (T_{amb} = 25 °C)

Order code	I_{RM} max@V_{RM}			V_{BR} @I_R (1)			V_{CL} @I_{PP} 10/1000 µs		R_D 10/1000 µs	V_{CL} @I_{PP} 8/20 µs		R_D 8/20 µs	αT (2)
	25 °C	85 °C		min.	typ.		max.			max.			max
	µA		V	V		mA	V(3)	A(4)	Ω	V(3)	A(4)	Ω	10-4/ °C
SM4T6V7CAY	20	50	5	6.4	6.74	10	9.2	43.5	0.049	13.4	174	0.036	5.7
SM4T18AY/CAY	0.2	1	15	16.7	17.6	1	24.4	16.4	0.361	32.5	71	0.197	8.8
SM4T21AY/CAY	0.2	1	18	20	21.1	1	29.2	13.7	0.514	39.3	59	0.291	9.2
SM4T23AY/CAY	0.2	1	20	22.2	23.4	1	32.4	12.3	0.637	42.8	54	0.338	9.4
SM4T26AY/CAY	0.2	1	22	24.4	25.7	1	35.5	11.2	0.76	48.3	48	0.444	9.6
SM4T28AY/CAY	0.2	1	24	26.7	28.1	1	38.9	10.3	0.912	50	46	0.446	9.6
SM4T30AY/CAY	0.2	1	26	28.9	30.4	1	42.1	9.5	1.07	53.5	43	0.502	9.7
SM4T33AY/CAY	0.2	1	28	31.1	32.7	1	45.4	8.8	1.26	59	39	0.632	9.8
SM4T35AY/CAY	0.2	1	30	33.3	35.1	1	48.4	8.3	1.39	64.3	36	0.762	9.9
SM4T39AY/CAY	0.2	1	33	36.7	38.6	1	53.3	7.5	1.7	69.7	33	0.884	10
SM4T47AY/CAY	0.2	1	40	44.4	46.7	1	64.5	6.2	2.49	84	27	1.3	10.1
SM4T56AY/CAY	0.2	1	48	53.3	56.1	1	77.4	5.2	3.56	100	23	1.79	10.3
SM4T68AY/CAY	0.2	1	58	64.4	67.8	1	93.6	4.3	5.21	121	19	2.62	10.4

1. Pulse test: t_p < 50 ms
2. To calculate maximum clamping voltage at other surge level, use the following formula: $V_{CL}max = V_{CL} - R_D \times (I_{PP} - I_{PPappli})$ where $I_{PPappli}$ is the surge current in the application
3. To calculate V_{BR} or V_{CL} versus junction temperature, use the following formulas:
   V_{BR} @ $T_J = V_{BR}$ @ 25 °C x (1 + αT x (T_J - 25))
   V_{CL} @ $T_J = V_{CL}$ @ 25 °C x (1 + αT x (T_J - 25))
4. Surge capability given for both directions for unidirectional and bidirectional types.

Figure 3. Peak pulse power dissipation versus initial junction temperature

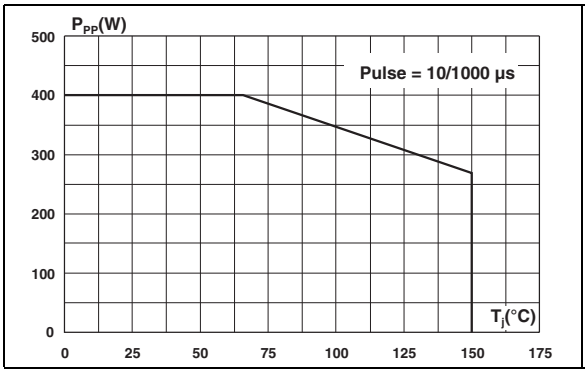


Figure 4. Peak pulse power versus exponential pulse duration (T_j initial = 25 °C)

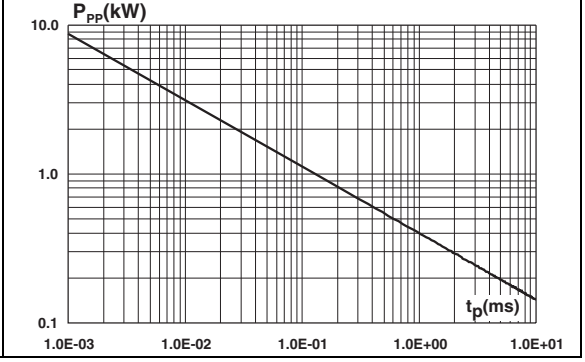


Figure 5. Clamping voltage versus peak pulse current (exponential waveform, maximum values)

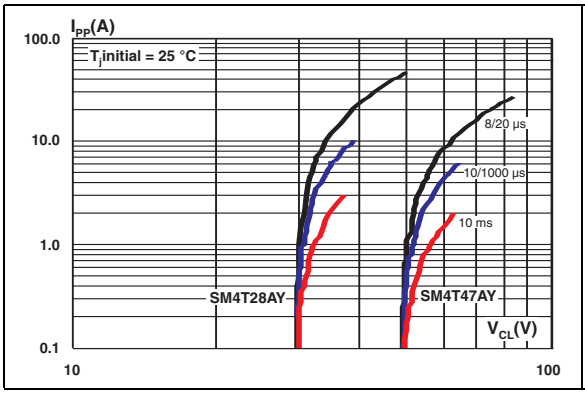


Figure 6. Junction capacitance versus reverse applied voltage for unidirectional types (typical values)

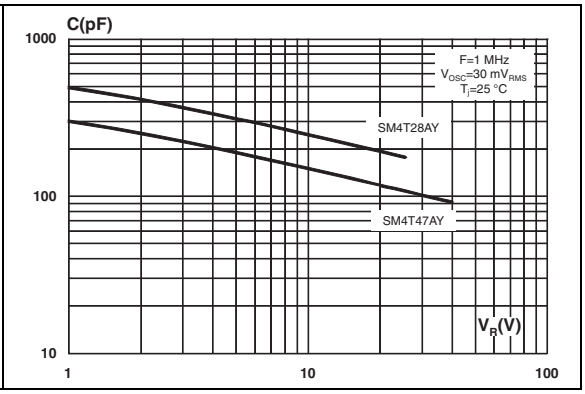


Figure 7. Junction capacitance versus reverse applied voltage for bidirectional types (typical values)

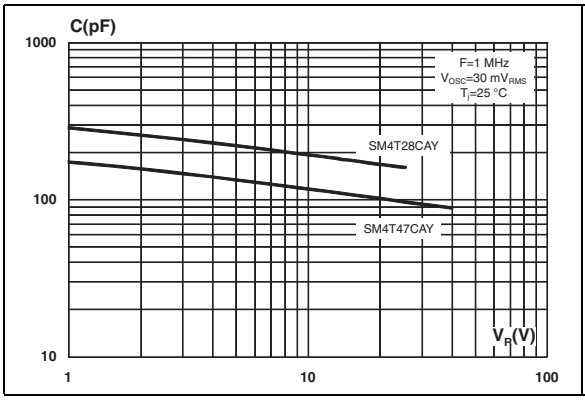


Figure 8. Relative variation of thermal impedance, junction to ambient, versus pulse duration

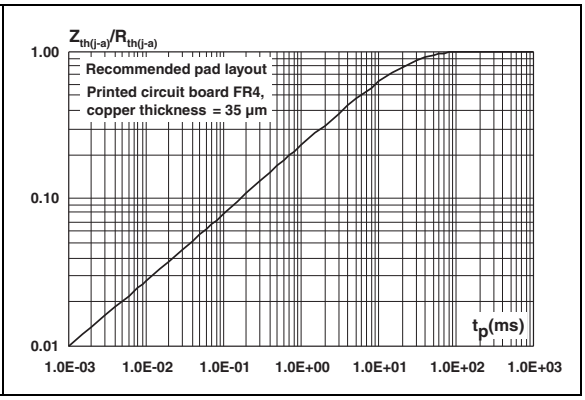


Figure 9. Thermal resistance junction to ambient versus copper surface under each lead

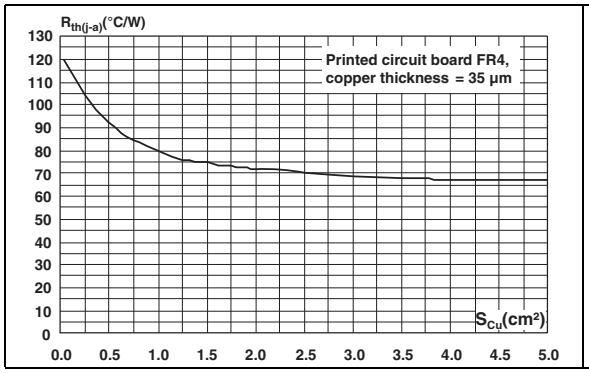


Figure 10. Leakage current versus junction temperature (typical values)

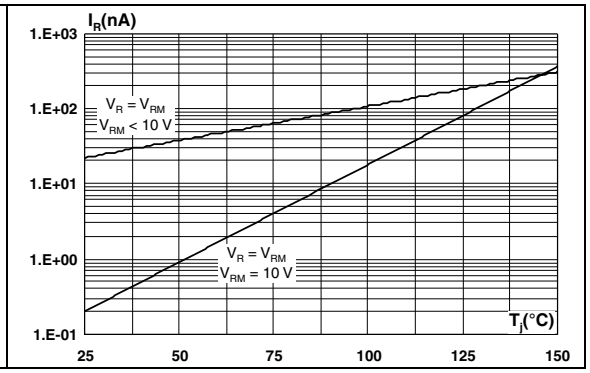


Figure 11. Peak forward voltage drop versus peak forward current (typical values)

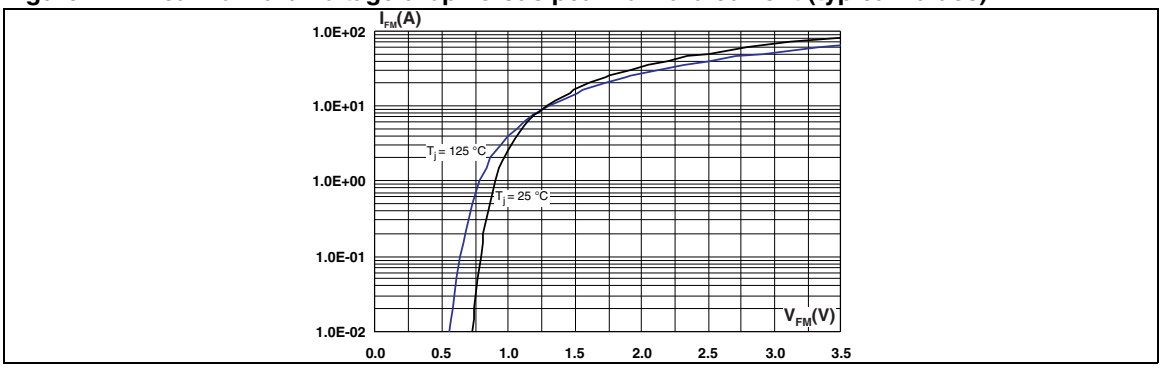


Figure 12. ISO7637-2 pulse 1 response (V_S = -100 V)

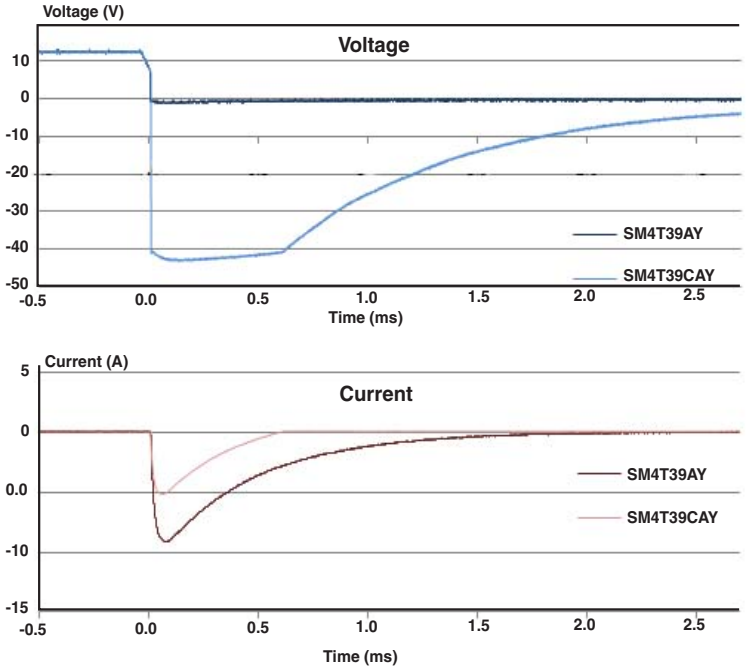


Figure 13. ISO7637-2 pulse 2 response (V_S = 50 V)

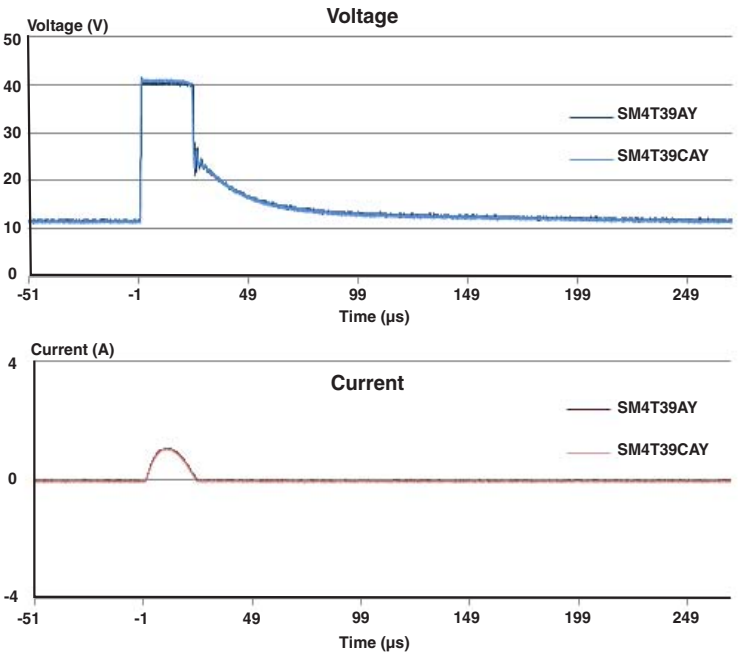


Figure 14. ISO7637-2 pulse 3a response (V_S = -150 V)

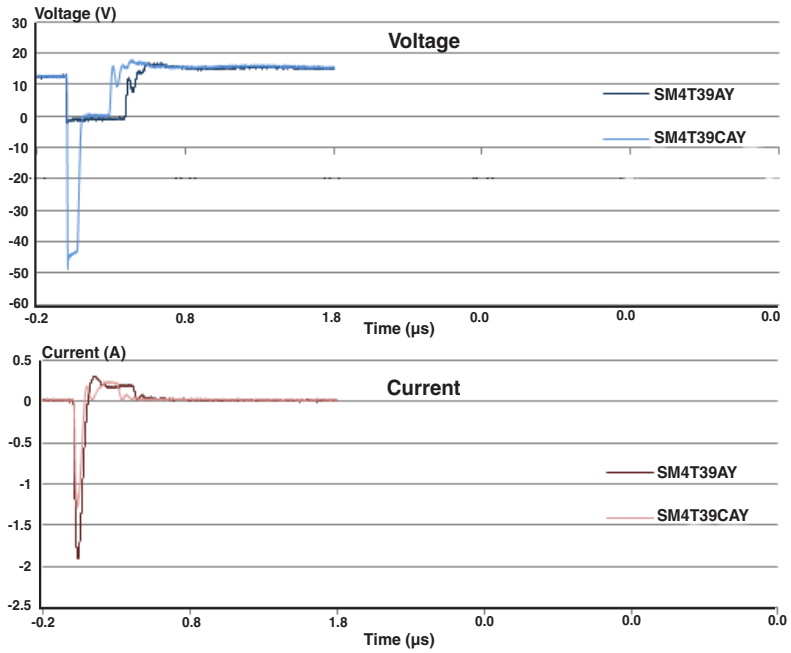
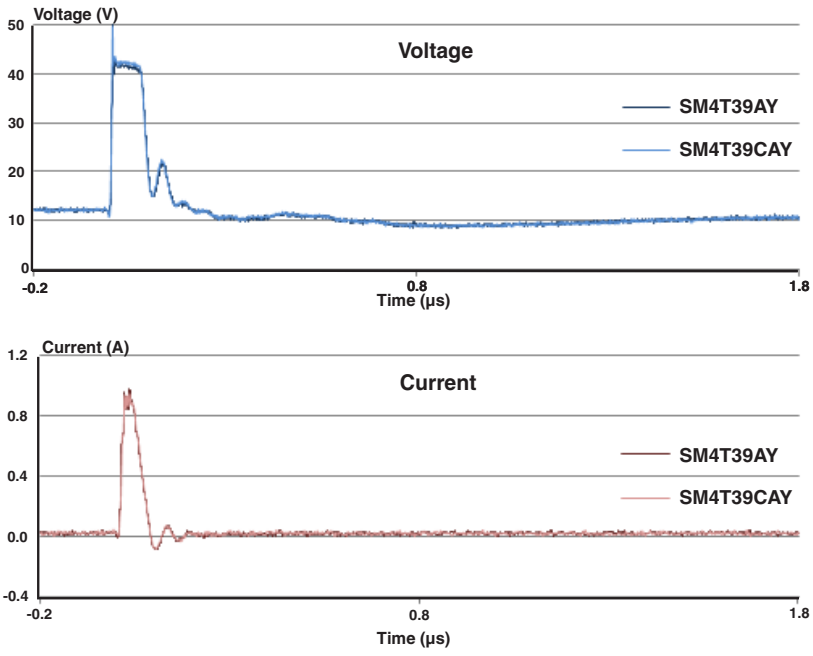


Figure 15. ISO7637-2 pulse 3b response (V_S = 100 V)



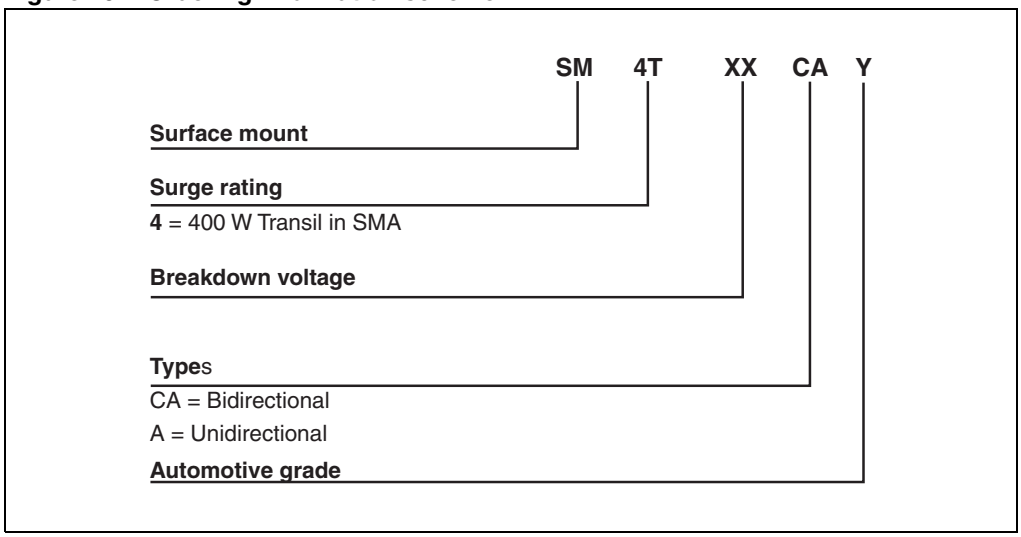
Note: ISO7637-2 pulses responses are not applicable for product with a stand off voltage lower than the average battery voltage (13.5 V).

2 Application and design guidelines

More information is available in the Application note AN2689 “Protection of automotive electronics from electrical hazards, guidelines for design and component selection”.

3 Ordering information scheme

Figure 16. Ordering information scheme

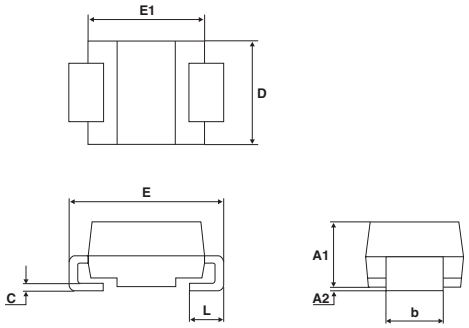


4 Package information

- Case: JEDEC DO-214AB molded plastic over planar junction
- Terminals: solder plated, solderable as per MIL-STD-750, Method 2026
- Polarity: for unidirectional types the band indicates cathode
- Flammability: epoxy is rated UL 94, V0
- RoHS package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Table 4. SMA dimensions



Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A1	1.90	2.45	0.075	0.094
A2	0.05	0.20	0.002	0.008
b	1.25	1.65	0.049	0.065
c	0.15	0.40	0.006	0.016
D	2.25	2.90	0.089	0.114
E	4.80	5.35	0.189	0.211
E1	3.95	4.60	0.156	0.181
L	0.75	1.50	0.030	0.059

Figure 17. SMA footprint dimensions in mm (inches)

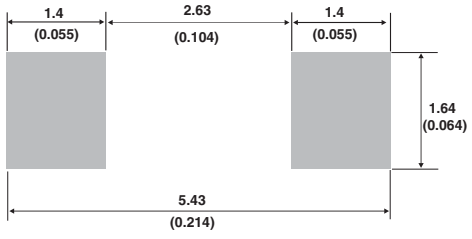
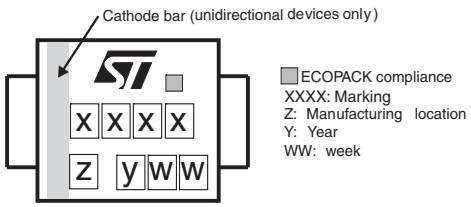


Figure 18. Marking layout(1)



1. Marking layout can vary according to assembly location.

Table 5. Marking

Order code	Marking	Order code	Marking
		SM4T6V7CAY	AAY
SM4T18AY	BMY	SM4T18CAY	AJY
SM4T21AY	DUQY	SM4T21CAY	DBQY
SM4T23AY	DURY	SM4T23CAY	DBRY
SM4T26AY	DUSY	SM4T26CAY	DBSY
SM4T28AY	DUTY	SM4T28CAY	DBTY
SM4T30AY	DUUY	SM4T30CAY	DBUY
SM4T33AY	CGY	SM4T33CAY	CHY
SM4T35AY	CKY	SM4T35CAY	CLY
SM4T39AY	CMY	SM4T39CAY	CNY
SM4T47AY	DUZY	SM4T47CAY	DBZY
SM4T56AY	CXY	SM4T56CAY	CYY
SM4T68AY	EUFY	SM4T68CAY	EBFY

5 Ordering information

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
SM4TxxxAY/CAY(1)	See *Table 5 on page 10*	SMA	0.072 g	5000	Tape and reel

1. Where xxx is nominal value of V_{BR} and A or CA indicates unidirectional or bidirectional version. See *Table 3* for list of available devices and their order codes

6 Revision history

Table 7. Document revision history

Date	Revision	Changes
08-Sep-2010	1	Initial release.

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